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·	Application No.	Applicant(s)	
A	10/743,216	KIM ET AL.	
Notice of Allowability	Examiner	Art Unit	
	LOHA BEN	2873	
The MAILING DATE of this communication app All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85 NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT F of the Office or upon petition by the applicant. See 37 CFR 1.31	S (OR REMAINS) CLOSED in i) or other appropriate commu RIGHTS. This application is so	this application. If not included nication will be mailed in due co	ourse. THIS
1. This communication is responsive to Applicants' application	on dated December 22, 2003.		
2. 🔀 The allowed claim(s) is/are <u>1-33</u> .			
3. 🗵 The drawings filed on 22 December 2003 are accepted by	y the Examiner.		
 4. Acknowledgment is made of a claim for foreign priority unally All b) Some* c) None of the: 1. Certified copies of the priority documents have 2. Certified copies of the priority documents have 3. Copies of the certified copies of the priority documents have International Bureau (PCT Rule 17.2(a)). 	re been received. re been received in Application	n No	n from the
* Certified copies not received:		·	
Applicant has THREE MONTHS FROM THE "MAILING DATE" noted below. Failure to timely comply will result in ABANDONI THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.	of this communication to file MENT of this application.	a reply complying with the requi	irements
5. A SUBSTITUTE OATH OR DECLARATION must be subr INFORMAL PATENT APPLICATION (PTO-152) which giv			TICE OF
 CORRECTED DRAWINGS (as "replacement sheets") mu (a) including changes required by the Notice of Draftsper 1) hereto or 2) to Paper No./Mail Date (b) including changes required by the attached Examiner Paper No./Mail Date Identifying indicia such as the application number (see 37 CFR each sheet. Replacement sheet(s) should be labeled as such in 	rson's Patent Drawing Review r's Amendment / Comment or 1.84(c)) should be written on the	in the Office action of e drawings in the front (not the ba R 1.121(d).	
 DEPOSIT OF and/or INFORMATION about the depo- attached Examiner's comment regarding REQUIREMENT 			te the
Attachment(s) 1. ☑ Notice of References Cited (PTO-892) 2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-948) 3. ☐ Information Disclosure Statements (PTO-1449 or PTO/SB/Paper No./Mail Date 4. ☐ Examiner's Comment Regarding Requirement for Deposit of Biological Material	6. ☐ Interview Su Paper No./f (08), 7. ☑ Examiner's A	ormal Patent Application (PTO- mmary (PTO-413), Mail Date Amendment/Comment Statement of Reasons for Allowa	,
Loha Ben Primary Examiner			

EXAMINER'S AMENDMENT

An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

The application has been amended as follows:

In the Claims

In claim 1: lines 4, 7, 11 and 17, "die" has been deleted to provide antecedent basis for lines 8 and 9, 15 and 19 of claim 1; line 2 of claims 5-7; lines 2 and 4 of claim 8; lines 2 and 3 of claim 10; and lines 3-5 of claim 12.

The dependency of claim 12 has been changed from "claim 13" to – claim 1 --.

See dependency of claim 27 for comparison.

In claim 16: lines 4 and 11, "die" has been deleted to be consistent with lines 8, 9, 15 and 18 of claim 16, and line 4 of claim 27.

Fully amended texts are given below:

- 1. (Currently Amended) A printed circuit board assembly with optical devices packaged therein, comprising:
 - a plate type heat spreader;
- a driving printed circuit board [[die]] bonded to a top of the heat spreader to convert electrical and optical signals to optical and electrical signals, respectively;
- a driving integrated circuit [[die]] bonded to the top of the heat spreader and wire bonded to the driving printed circuit board;

an optical signal transmitting/receiving printed circuit board [[die]] bonded to a bottom of the heat spreader, with at least one waveguide for transmitting optical signals being arranged therein;

at least one optical signal coupling block mounted on the optical signal transmitting/receiving printed circuit board; and

optical devices [[die]] bonded to the bottom of the heat spreader and wire bonded to the optical signal transmitting/receiving printed circuit board to transfer optical signals to the optical signal coupling block.

- 12. (Currently Amended) The printed circuit board assembly according to claim [[13]] 1, further comprising alignment targets attached to predetermined positions of the optical devices and the optical signal transmitting/receiving printed circuit board to accurately arrange the optical devices.
- 16. (Currently Amended) A printed circuit board assembly with optical devices packaged therein, comprising:
 - a plate type heat spreader;
- a driving printed circuit board [[die]] bonded to a top of the heat spreader to convert electrical and optical signals to optical and electrical signals, respectively;
- a driving integrated circui arranged on the driving printed circuit board and flipchip bonded to the driving printed circuit board;

an optical signal transmitting/receiving printed circuit board [[die]] bonded to a bottom of the heat spreader, with at least one waveguide for transferring optical signals being arranged therein;

at least one optical signal coupling block mounted on the optical signal transmitting/receiving printed circuit board; and

optical devices arranged on the optical signal transmitting/receiving printed circuit board and flip-chip bonded thereto to transfer optical signals to the optical signal coupling block.

REASONS FOR ALLOWANCE

The following is an examiner's statement of reasons for allowance: Best reference of record is Chakravorty et al. The latter, despite the similarity of its device with that of the present invention as to optical and electronic components of the assembly that are arranged in connection with the integrated circuit and the printed circuit board, fails to teach or fairly suggest that the printed circuit board and the integrated circuit are positioned on the same surface of a plate type heat spreader. The assembly of the patent has two substrates (not one heat spreader), each having first and second surfaces. Each first surface has an integrated circuit thereon, and both second surfaces have one printed circuit board bonded thereto. This difference alone would signify the divergent subject matter between the two inventions.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably

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accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Loha Ben whose telephone number is (571) 272-2323. The examiner can normally be reached on Monday to Saturday, generally between 12:00 noon and 8:00 p.m.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Georgia Y. Epps, can be reached on Monday to Friday, at (571) 272-2328. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

December 22, 2004

Lona Ben Primary Examiner